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## **Pixus Technologies Announces New Overview Brochures**

Waterloo, Ontario — Apr 18, 2018 – Pixus Technologies, a provider of embedded computing and enclosure solutions, has released a new overview brochure that highlights the companies capabilities and core product lines.

The new Pixus overview brochure features a brief history of the company, details on the 4 main product lines, and notes on it's customization, ruggedization, and simulation/analysis capabilities. The main product lines includes Chassis Platforms, Backplanes, Instrumentation Cases, and Components. As OpenVPX is a core product line for the company, the architecture is the primary focus of the brochure. Other standards included are cPCI Serial, AdvancedTCA, MicroTCA, and legacy VME/64x and CompactPCI.

The brochure will be posted on the companies literature page at <http://www.pixustechnologies.com/about-pixus-technologies/literature>. For more information on Pixus' products and services, contact the company at [info@pixustechnologies.com](mailto:info@pixustechnologies.com) or call one of the local offices listed on the Web site.

### **About Pixus Technologies**

Leveraging over 25 years of innovative standard products, the Pixus team is comprised of industry experts in electronics packaging. Founded in 2009 by senior management from Kaparel Corporation, a Rittal company, Pixus Technologies' embedded backplanes and systems are focused primarily on ATCA, OpenVPX, MicroTCA, and custom designs. Pixus also has an extensive offering of VME-based and cPCI-based solutions. In May 2011, Pixus Technologies became the sole authorized North and South American supplier of the electronic packaging products previously offered by Kaparel Corporation and Rittal.